



Larry Hogan  
Governor

Boyd K. Rutherford  
Lt. Governor

Mary Pat Seurkamp, Ph.D.  
Chair

James D. Fielder, Jr., Ph.D.  
Secretary

December 14, 2022

Dr. Darryll Pines  
President  
University of Maryland, College Park  
1101 Thomas V. Miller, Jr. Administration Building  
College Park, Maryland 20742

Dear President Pines:

The Maryland Higher Education Commission reviewed a request from University of Maryland, College Park to change the title of the program listed below.

I am pleased to inform you that the program proposal is approved for implementation in Spring 2023.

For the purposes of providing enrollment and degree data to the Commission, please use the following HEGIS and CIP codes.

Program Title	Award	Credits	HEGIS	CIP	Modality
<b>Old:</b> Embedded Systems and Internet of Things <b>New:</b> Cyber-Physical Systems Engineering	B.S.	122	0799.00	14.0999	On-Campus

I wish you continued success in your educational endeavors.

Sincerely,

Dr. James D. Fielder  
Secretary

JDF:LB:rr

C: Dr. Darlene Brannigan Smith, Interim Associate Vice Chancellor, Academic Affairs, USM  
Michael Colson, Sr., Coordinator for Academic Programs  
Dr. Jennifer King Rice, Senior Vice President and Provost, University of Maryland, College Park

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